

Amendments to the Claims:

This listing of the claims will replace all prior versions, and listings of claims in the application:

1. (Currently Amended) A method of manufacturing a display device having an OLED display and a touch screen, the OLED display including components that are sensitive to high temperatures, and the touch screen including a resistive film, comprising the steps of:
 - a) providing a transparent substrate having two sides;
 - b) forming a flat-panel organic light emitting diode display on a ~~first one~~ side of the transparent substrate that emits light through the transparent substrate;
 - c) forming a transparent resistive film using a low temperature technique on the ~~second other~~ side of the substrate, opposite the first side of the substrate; and
 - d) forming a resistive touch screen on the transparent resistive film through which light is emitted from the OLED display, and wherein the transparent resistive film is formed on the ~~second other~~ side of the substrate in step c) after forming the organic light emitting diode display on the first one side of the substrate in step b), and wherein the low temperature technique does not subject the substrate to temperatures higher than 150°C.
2. (Withdrawn) The method claimed in claim 1, wherein the low temperature technique is low temperature sputtering.
3. (Original) The method claimed in claim 1, wherein the low temperature technique is coating a resistive polymer material.
4. (Original) The method claimed in claim 3, wherein the coating technique is spin coating.
5. (Withdrawn) The method claimed in claim 3, wherein the coating technique is web coating.

6. (Withdrawn) The method claimed in claim 3, wherein the coating technique is drop jet coating.

7. (Original) The method claimed in claim 3, wherein the resistive polymer material is polythiophene.

8. (Original) The method claimed in claim 1, wherein the OLED display is an active matrix display.

9. (Withdrawn) The method claimed in claim 1, wherein the OLED display is a passive matrix display.

10. (Withdrawn) A display device manufactured according to the method of claim 1.

11. (Withdrawn) The method claimed in claim 1, wherein the resistive film is indium tin oxide (ITO).